

### Static Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)

	Parameter		Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	N-Ch	30	—	—	V	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$
		P-Ch	-30	—	—		$V_{GS} = 0\text{V}, I_D = -250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	N-Ch	—	0.032	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}, I_D = 1\text{mA}$
		P-Ch	—	-0.037	—		Reference to $25^\circ\text{C}, I_D = -1\text{mA}$
$R_{DS(\text{on})}$	Static Drain-to-Source On-Resistance	N-Ch	—	0.038	0.045	$\Omega$	$V_{GS} = 10\text{V}, I_D = 5.8\text{A}$ ③
			—	0.055	0.075		$V_{GS} = 4.5\text{V}, I_D = 4.9\text{A}$ ③
		P-Ch	—	0.070	0.090		$V_{GS} = -10\text{V}, I_D = -4.3\text{A}$ ③
			—	0.130	0.180		$V_{GS} = -4.5\text{V}, I_D = -3.7\text{A}$ ③
$V_{GS(\text{th})}$	Gate Threshold Voltage	N-Ch	1.0	—	3.0	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
		P-Ch	-1.0	—	-3.0		$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$
$g_{fs}$	Forward Transconductance	N-Ch	5.2	—	—	S	$V_{DS} = 15\text{V}, I_D = 2.4\text{A}$ ③
		P-Ch	2.5	—	—		$V_{DS} = -24\text{V}, I_D = -1.8\text{A}$ ③
$I_{DSS}$	Drain-to-Source Leakage Current	N-Ch	—	—	1.0	$\mu\text{A}$	$V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$
		P-Ch	—	—	-1.0		$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}$
		N-Ch	—	—	25		$V_{DS} = 24\text{V}, V_{GS} = 0\text{V}, T_J = 125^\circ\text{C}$
		P-Ch	—	—	-25		$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}, T_J = 125^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage		—	—	$\pm 100$	nA	$V_{GS} = \pm 20\text{V}$

### Dynamic Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)

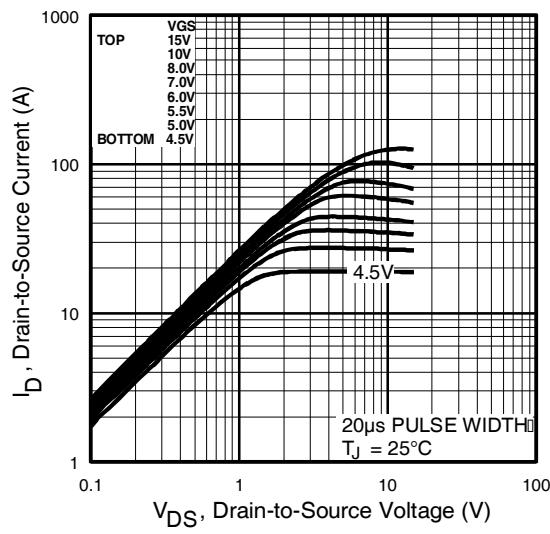
	Parameter		Min.	Typ.	Max.	Units	Conditions
$Q_g$	Total Gate Charge	N-Ch	—	—	25	nC	N-Channel $I_D = 2.4\text{A} V_{DS} = 24\text{V}, V_{GS} = 10\text{V}$
		P-Ch	—	—	25		P-Channel ③
$Q_{gs}$	Gate-to-Source Charge	N-Ch	—	—	2.9	ns	$V_{DD} = 15\text{V}, ID=2.4\text{A}, RG = 6.0\Omega$ $R_D = 6.2\Omega$ P-Channel ③
		P-Ch	—	—	2.9		
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	N-Ch	—	—	7.9		$V_{DD} = -15\text{V}, ID=-1.8\text{A}, RG = 6.0\Omega$ $R_D = 8.2\Omega$
		P-Ch	—	—	9.0		
$t_{d(on)}$	Turn-On Delay Time	N-Ch	—	6.8	—		Between lead, 6mm (0.25in.) from package and center of die contact
		P-Ch	—	11	—		
$t_r$	Rise Time	N-Ch	—	21	—		N-Channel $V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1.0\text{Mhz}$
		P-Ch	—	17	—		
$t_{d(off)}$	Turn-Off Delay Time	N-Ch	—	22	—		P-Channel $V_{GS} = 0\text{V}, V_{DS} = -25\text{V}, f = 1.0\text{Mhz}$
		P-Ch	—	25	—		
$t_f$	Fall Time	N-Ch	—	7.7	—		N-Channel $V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1.0\text{Mhz}$
		P-Ch	—	18	—		
$L_D$	Internal Drain Inductance	N-P	—	4.0	—	nH	Between lead, 6mm (0.25in.) from package and center of die contact
$L_S$	Internal Source Inductance	N-P	—	6.0	—		
$C_{iss}$	Input Capacitance	N-Ch	—	520	—		P-Channel $V_{GS} = 0\text{V}, V_{DS} = -25\text{V}, f = 1.0\text{Mhz}$
		P-Ch	—	440	—		
$C_{oss}$	Output Capacitance	N-Ch	—	180	—		N-Channel $V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1.0\text{Mhz}$
		P-Ch	—	200	—		
$C_{rss}$	Reverse Transfer Capacitance	N-Ch	—	72	—		P-Channel $V_{GS} = 0\text{V}, V_{DS} = -25\text{V}, f = 1.0\text{Mhz}$
		P-Ch	—	93	—		

### Diode Characteristics

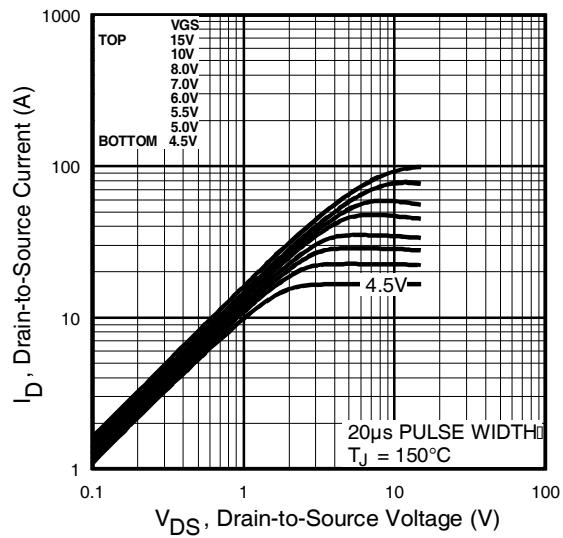
	Parameter		Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	N-Ch	—	—	3.1	A	$T_J = 25^\circ\text{C}, I_S = 1.8\text{A}, V_{GS} = 0\text{V}$ ③
		P-Ch	—	—	-3.1		
$I_{SM}$	Pulsed Source Current (Body Diode) ①	N-Ch	—	—	46		$T_J = 25^\circ\text{C}, I_S = -1.8\text{A}, V_{GS} = 0\text{V}$ ③
		P-Ch	—	—	-34		
$V_{SD}$	Diode Forward Voltage	N-Ch	—	—	1.0	V	$T_J = 25^\circ\text{C}, I_F = 2.4\text{A} di/dt = 100\text{A}/\mu\text{s}$
		P-Ch	—	—	-1.0		
$t_{rr}$	Reverse Recovery Time	N-Ch	—	47	71	ns	N-Channel $T_J = 25^\circ\text{C}, I_F = -1.8\text{A} di/dt = 100\text{A}/\mu\text{s}$
		P-Ch	—	53	80		
$Q_{rr}$	Reverse Recovery Charge	N-Ch	—	56	84	nC	P-Channel $T_J = 25^\circ\text{C}, I_F = -1.8\text{A} di/dt = 100\text{A}/\mu\text{s}$
		P-Ch	—	66	99		

Notes ① through ④ are on page 10

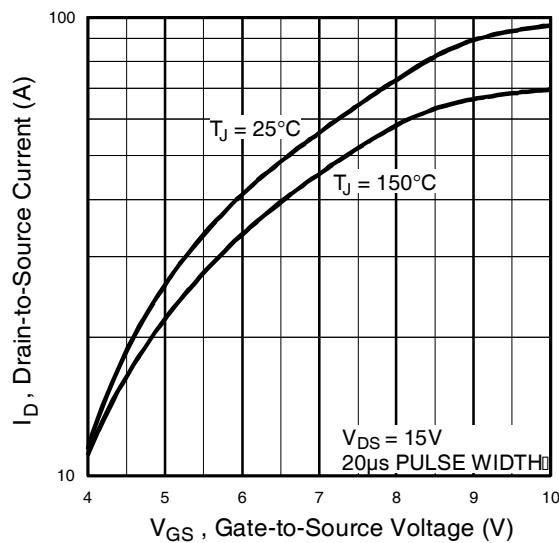
## N-Channel



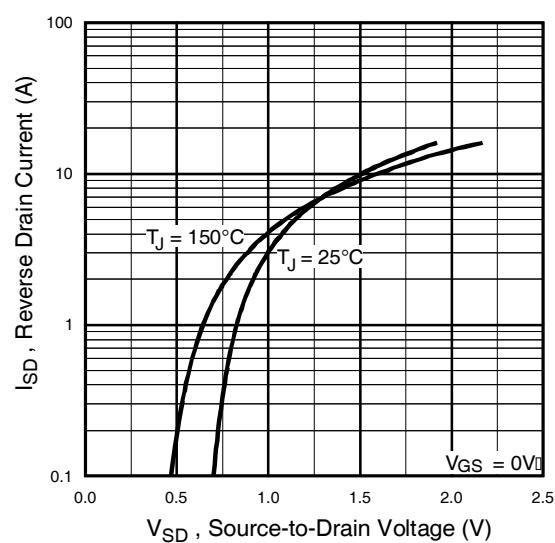
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics

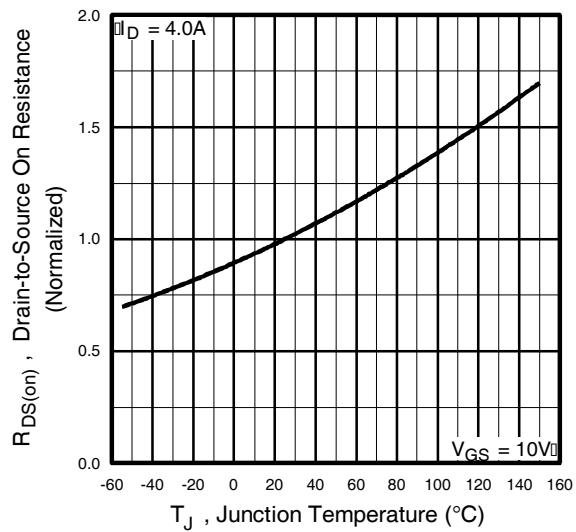


**Fig 3.** Typical Transfer Characteristics

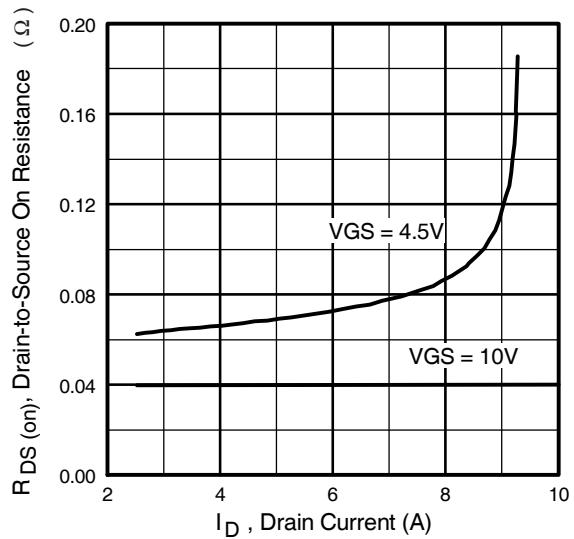


**Fig 4.** Typical Source-Drain Diode Forward Voltage

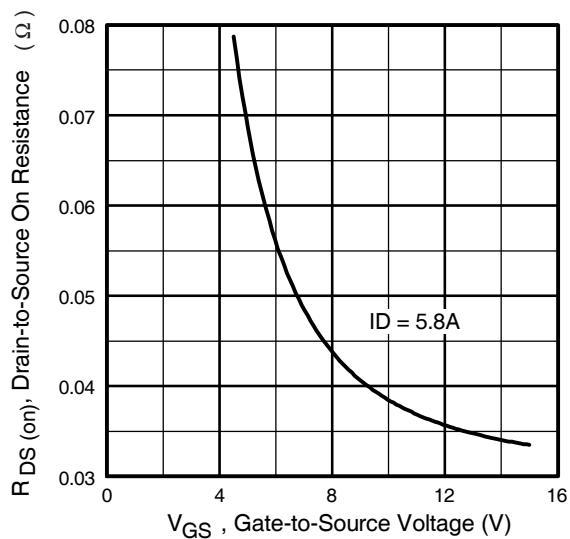
N-Channel



**Fig 5.** Normalized On-Resistance Vs. Temperature

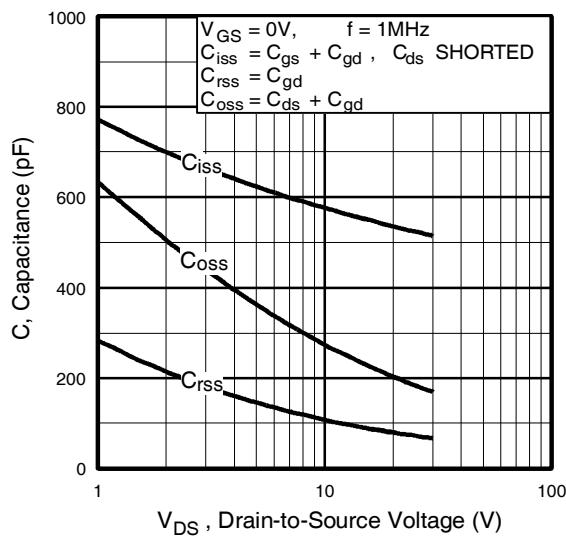


**Fig 6.** Typical On-Resistance Vs. Drain Current

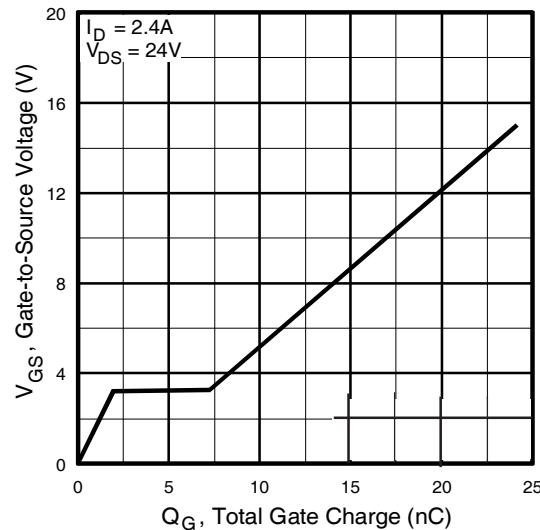


**Fig 7.** Typical On-Resistance Vs. Gate Voltage

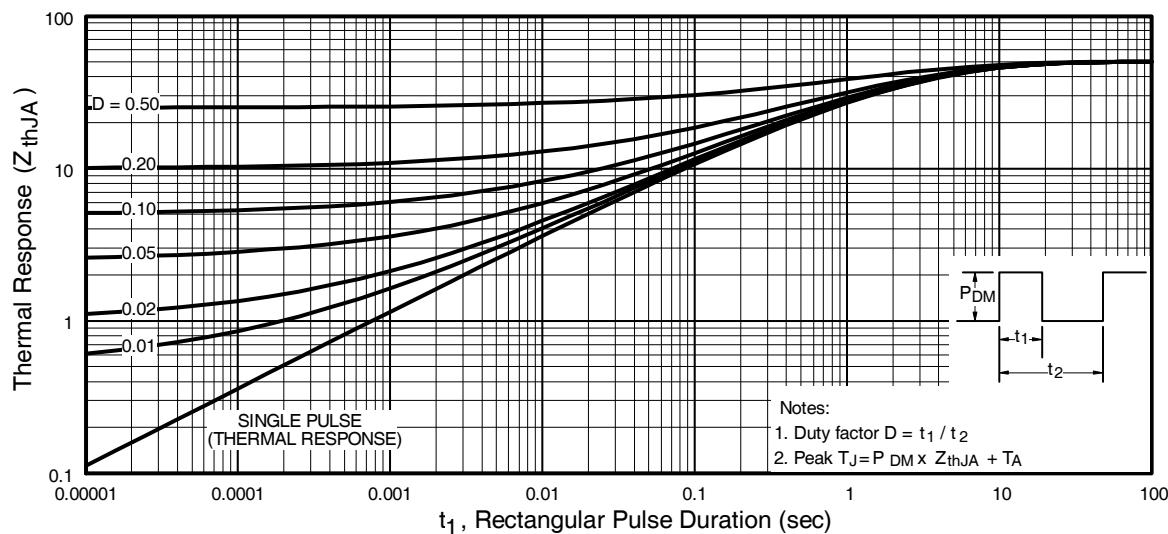
N-Channel



**Fig 8.** Typical Capacitance Vs.  
Drain-to-Source Voltage

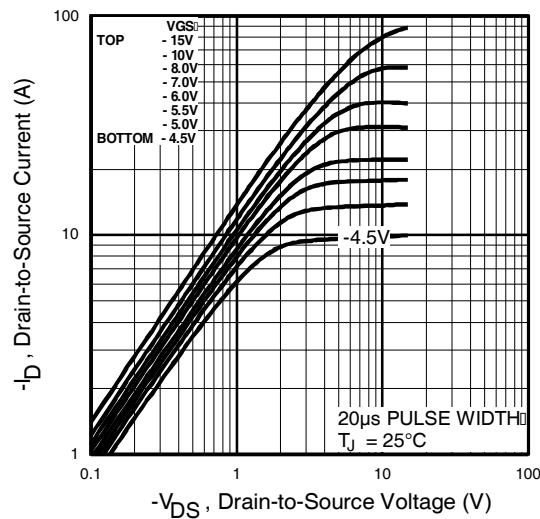
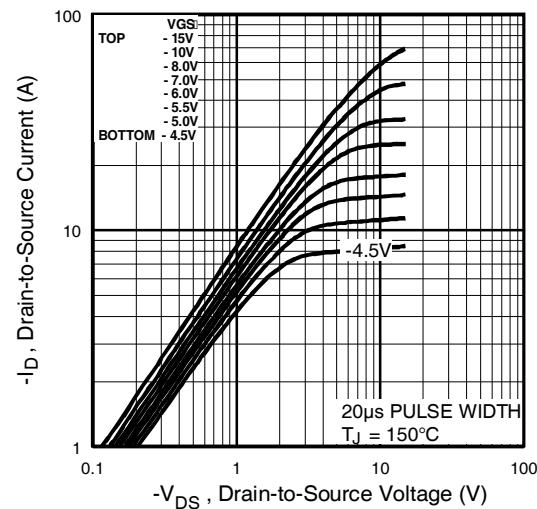
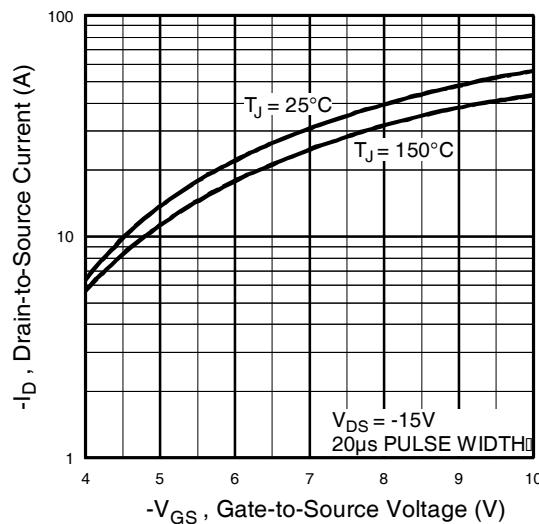
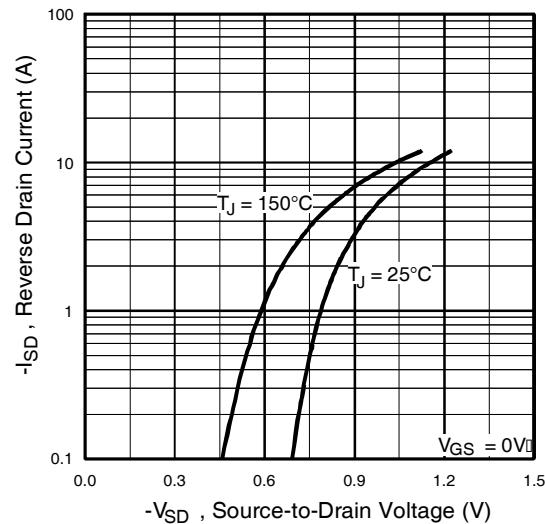


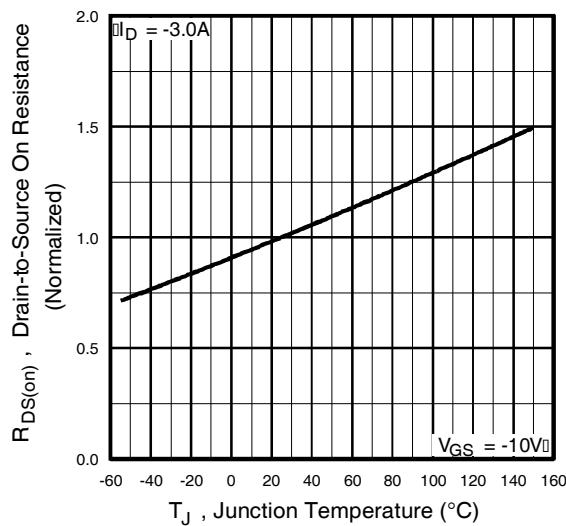
**Fig 9.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



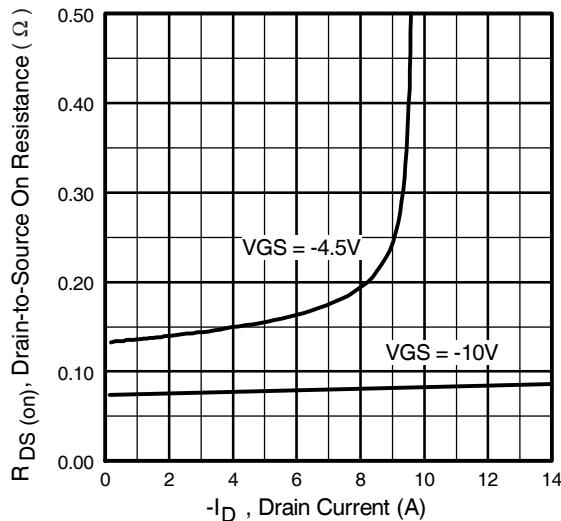
**Fig 10.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

## P-Channel

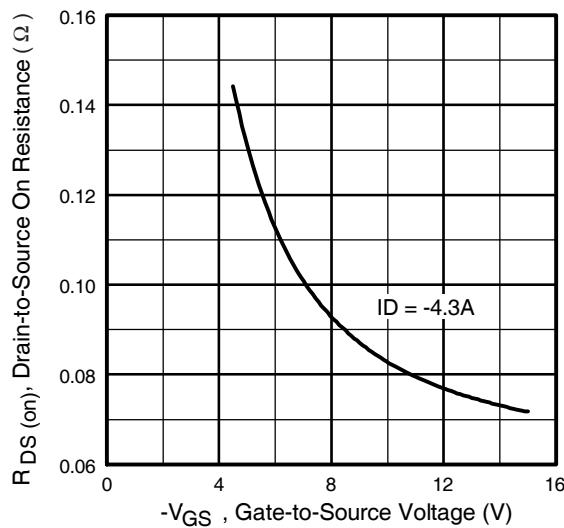
**Fig 11.** Typical Output Characteristics**Fig 12.** Typical Output Characteristics**Fig 13.** Typical Transfer Characteristics**Fig 14.** Typical Source-Drain Diode Forward Voltage



**Fig 15.** Normalized On-Resistance Vs. Temperature

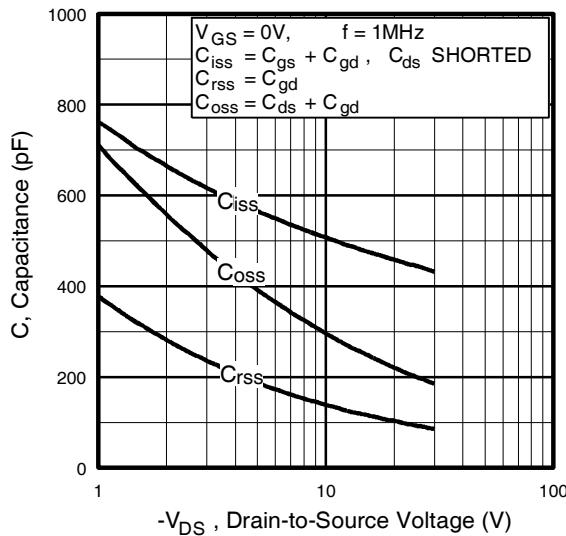


**Fig 16.** Typical On-Resistance Vs. Drain Current

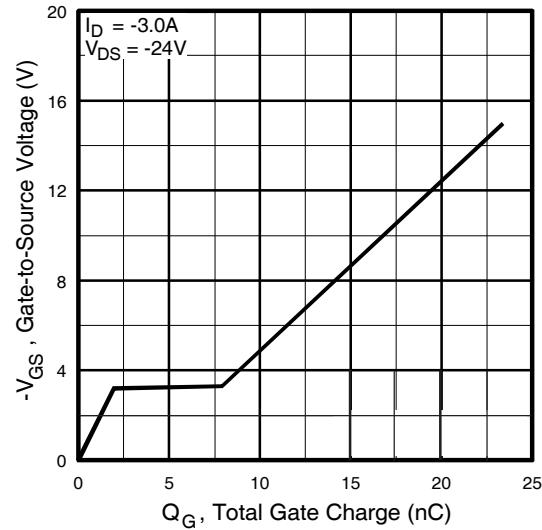


**Fig 17.** Typical On-Resistance Vs. Gate Voltage

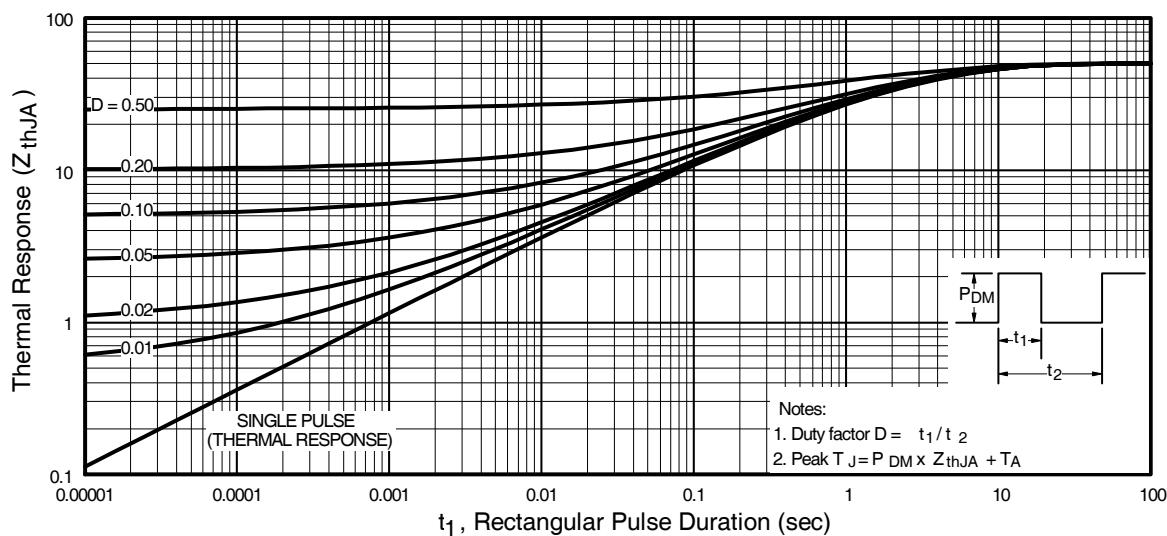
## P-Channel



**Fig 18.** Typical Capacitance Vs.  
Drain-to-Source Voltage



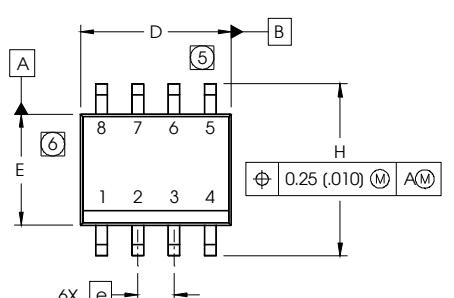
**Fig 19.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



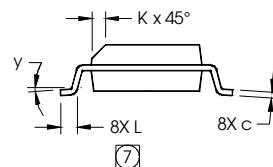
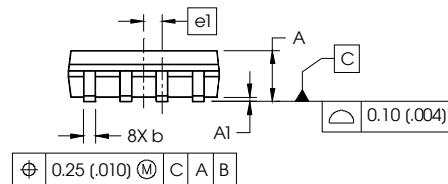
**Fig 20.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

## SO-8 Package Outline

Dimensions are shown in millimeters (inches)

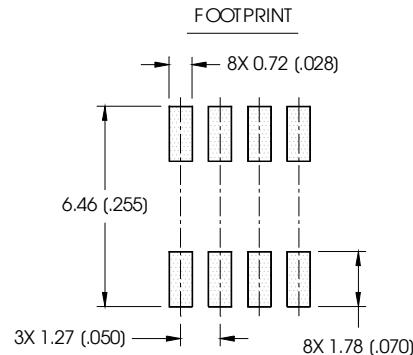


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050	BASIC	1.27	BASIC
e1	.025	BASIC	0.635	BASIC
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
Y	0°	8°	0°	8°

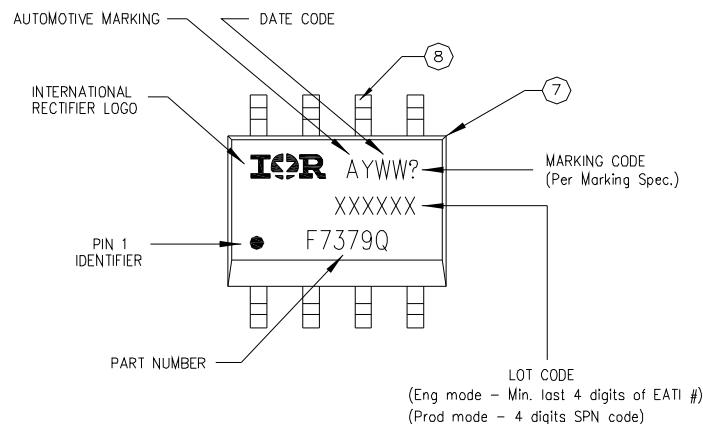


### NOTES:

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
5. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
6. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
7. DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.



## SO-8 Part Marking

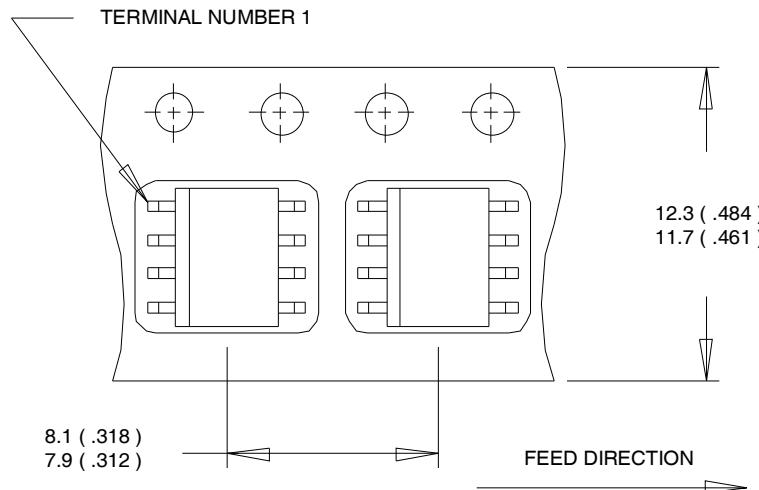


TOP MARKING (LASER)

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

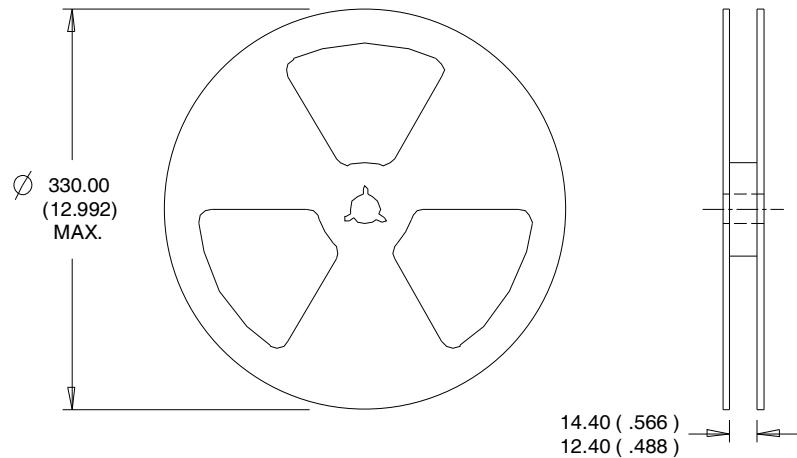
## SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



### NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



### NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② N-Channel  $I_{SD} \leq 2.4A$ ,  $dI/dt \leq 73A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 150^\circ C$   
P-Channel  $I_{SD} \leq -1.8A$ ,  $dI/dt \leq 90A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 150^\circ C$
- ③ Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$ .
- ④ Surface mounted on FR-4 board,  $t \leq 10sec$ .

**Qualification Information<sup>†</sup>**

<b>Qualification Level</b>		Automotive (per AEC-Q101) <sup>††</sup>	
Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
<b>Moisture Sensitivity Level</b>		SO-8	MSL1
<b>ESD</b>	Machine Model	N Ch: Class M2(+/- 150V ) <sup>†††</sup> (per AEC-Q101-002)	P Ch: Class M2(+/- 150V ) <sup>†††</sup>
	Human Body Model	N Ch : Class H1A(+/- 500V ) <sup>†††</sup> (per AEC-Q101-001)	P Ch: Class H0(+/- 250V ) <sup>†††</sup>
	Charged Device Model	N Ch: Class C5(+/- 2000V ) <sup>†††</sup> (per AEC-Q101-005)	P Ch: Class C5(+/- 2000V ) <sup>†††</sup>
<b>RoHS Compliant</b>		Yes	

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: <http://www.irf.com/>

<sup>††</sup> Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.

<sup>†††</sup> Highest passing voltage

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<http://www.irf.com/technical-info/>

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Tel: (310) 252-7105

**Revision History**

Date	Comments
3/10/2014	<ul style="list-style-type: none"><li>• Added "Logic Level Gate Drive" bullet in the features section on page 1</li><li>• Updated data sheet with new IR corporate template</li></ul>